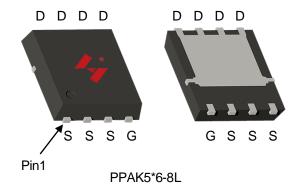


#### Single N-Channel Enhancement Mode MOSFET

#### **Feature**

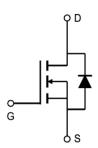
- 60V/48A
  - $R_{DS(ON)} = 10.5 \text{m}\Omega(\text{typ.}) \text{@Vgs} = 10 \text{V}$
  - $R_{DS(ON)} = 12.2 \text{m}\Omega(\text{typ.}) @V_{GS} = 4.5 \text{V}$
- 100% Avalanche Tested
- Reliable and Rugged
- Halogen- Free Devices Available

#### **Pin Description**



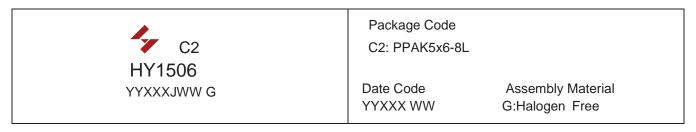
### **Applications**

- High Frequency Point-of-Load Synchronous Buck Converter
- Power Tool Application
- Networking DC-DC Power System



Single N-Channel MOSFET

### **Ordering and Marking Information**



Note: HUAYI lead -free products contain molding compounds/die attach materials and 100% matte tin plate Termi-Nation finish; which are fully compliant with RoHS. HUAYI lead -free products meet or exceed the lead-Free requirements of IPC/JEDEC J-STD-020 for MSL classification at lead-free peak reflow temperature. HUAYI defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

HUAYI reserves the right to make changes, corrections, enhancements, modifications, and improvements to this pr-oduct and/or to this document at any time without notice.



## **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Unit		
Common Rat	Common Ratings (Tc=25°C Unless Otherwise Noted)				
VDSS	Drain-Source Voltage		60	V	
Vgss	Gate-Source Voltage		±20	V	
TJ	Maximum Junction Temperature		150	°C	
Tstg	Storage Temperature Range		-55 to 150	°C	
Is	Source Current-Continuous(Body Diode) Tc=25°C		48	А	
Mounted on I	Mounted on Large Heat Sink				
Ідм	Pulsed Drain Current *	Tc=25°C	150	А	
1-	Cantinuana Brain Comment	Tc=25°C	48	А	
lσ	Continuous Drain Current	Tc=100°C	30	А	
1	Martin or Brown Biotherine	Tc=25°C	48	W	
PD	P <sub>D</sub> Maximum Power Dissipation Tc=100°C		19	W	
R₀JC	Thermal Resistance, Junction-to-Case		2.6	°C/W	
R <sub>eJA</sub>	Thermal Resistance, Junction-to-Ambient **		45	°C/W	
Eas	SinglePulsed-Avalanche Energy *** L=0.1mH		106	mJ	

Note: \* Repetitive rating; pulse width limited by max.junction temperature.

### **Electrical Characteristics**(Tc =25°C Unless Otherwise Noted)

Cumbal	Donometer.	Toot Conditions	HY1506		l losis	
Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit
Static Cha	racteristics					
BVDSS	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V,I <sub>DS</sub> =250μA	60	-	-	V
lana	Drain to Source Lookage Current	VDS=60V,VGS=0V	-	-	1	μΑ
IDSS	Drain-to-Source Leakage Current	Tj=125°C	-		50	μA
VGS(th)	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250µA	1	1.9	3	V
Igss	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	±100	nA
Procesus*	Drain-Source On-State Resistance	V <sub>GS</sub> =10V,I <sub>DS</sub> =20A	-	10.5	13	mΩ
Rds(on)*	Dialii-Source Oil-State Resistance	V <sub>GS</sub> =4.5V,I <sub>DS</sub> =20A	-	12.2	15	11122
Diode Characteristics						
V <sub>SD</sub> *	Diode Forward Voltage	IsD=20A,Vgs=0V	-	0.8	1.2	V
trr	Reverse Recovery Time		-	23	-	ns
Qrr	Reverse Recovery Charge		-	58	-	nC

<sup>\*\*</sup> Surface mounted on 1in2 FR-4 board.

<sup>\*\*\*</sup> Limited by TJmax , starting TJ=25°C, L = 0.1mH, Rg=  $25\Omega$ , Vgs =10V.

# HY1506C2



# Electrical Characteristics (Cont.) (Tc =25°C Unless Otherwise Noted)

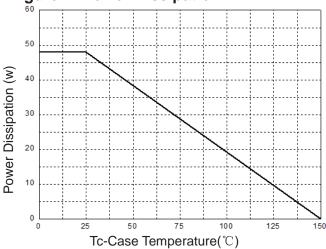
Cumbal	Donomotor	Test Conditions		HY1506		I I a i t
Symbol	Parameter	lest Conditions	Min	Тур.	Max	Unit
Dynamic (	Characteristics					
Rg	Gate Resistance	V <sub>GS</sub> =0V,V <sub>DS</sub> =0V,F=1MHz	-	1.2	-	Ω
Ciss	Input Capacitance	Vgs=0V,	-	2286	-	
Coss	Output Capacitance	V <sub>DS</sub> =48V,	-	187	-	pF
Crss	Reverse Transfer Capacitance	Frequency=1.0MHz	-	142	-	]
td(ON)	Turn-on Delay Time		-	13	-	
Tr	Turn-on Rise Time	$V_{DD}=20V,R_{G}=4\Omega,$	-	14	-	,,,
td(OFF)	Turn-off Delay Time	lps=20A,Vgs=10V	-	43	-	ns
Tf	Turn-off Fall Time		-	13	-	
Gate Charge Characteristics						
Qg	Total Gate Charge	\/ _49\/ \/ _40\/	-	52.6	-	
Qgs	Gate-Source Charge	$V_{DS} = 48V, V_{GS} = 10V,$ $I_{D} = 20A$	-	6.4	-	nC
Qgd	Gate-Drain Charge	ID-ZUM	-	15.3	-	

Note: \*Pulse test, pulse width  $\leq 300$ us, duty cycle  $\leq 2\%$ 



### **Typical Operating Characteristics**

**Figure 1: Power Dissipation** 



**Figure 2: Drain Current** 

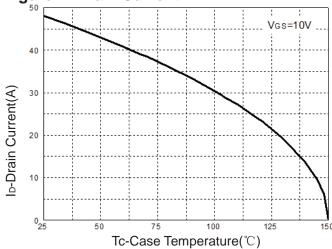
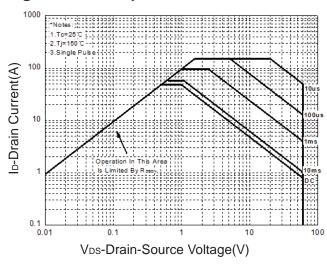
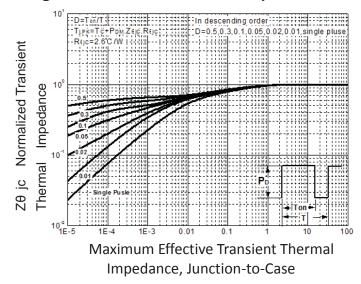


Figure 3: Safe Operation Area



**Figure 4: Thermal Transient Impedance** 



**Figure 5: Output Characteristics** 

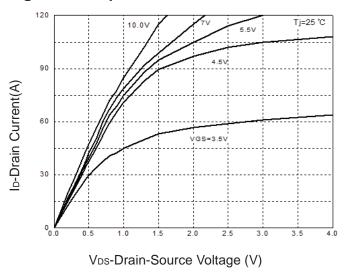
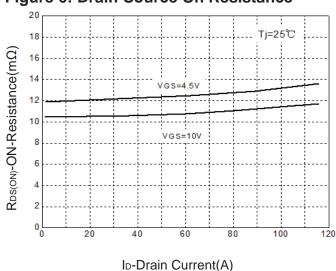


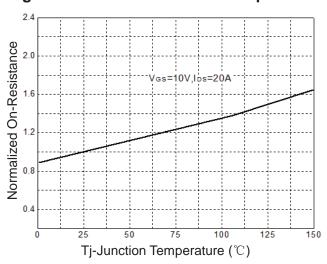
Figure 6: Drain-Source On Resistance





### **Typical Operating Characteristics(Cont.)**

Figure 7: On-Resistance vs. Temperature



**Figure 9: Capacitance Characteristics** 

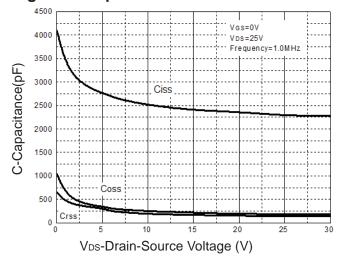
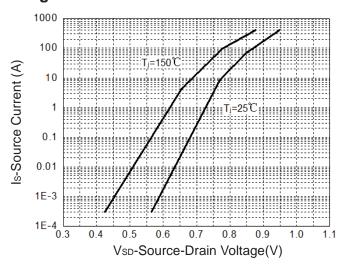
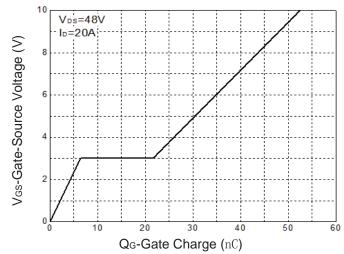


Figure 8: Source-Drain Diode Forward

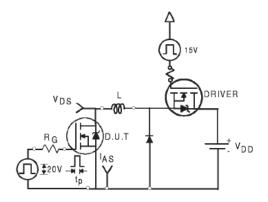


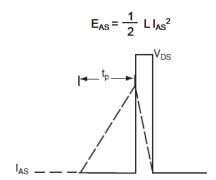
**Figure 10: Gate Charge Characteristics** 



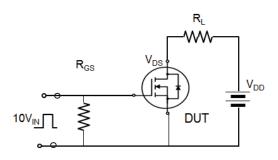


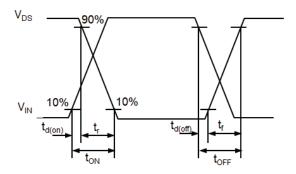
### **Avalanche Test Circuit**



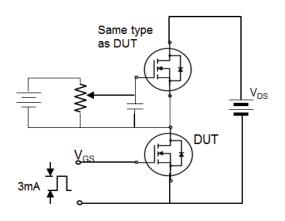


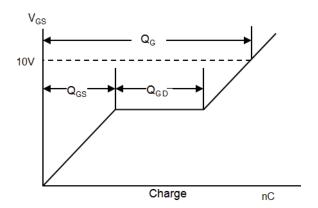
# **Switching Time Test Circuit**





# **Gate Charge Test Circuit**





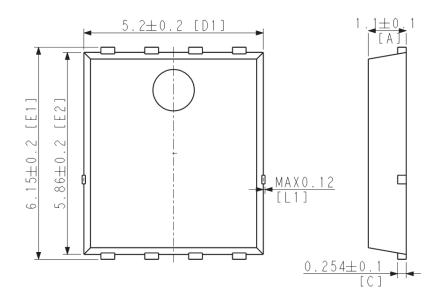


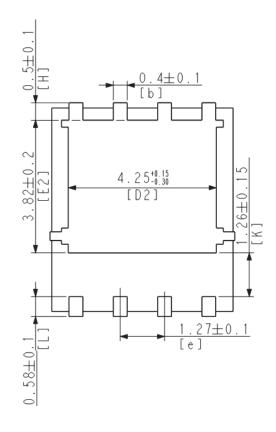
### **Device Per Unit**

Package Type	Unit	Quantity
PPAK5x6-8L	Reel	5000

## **Package Information**

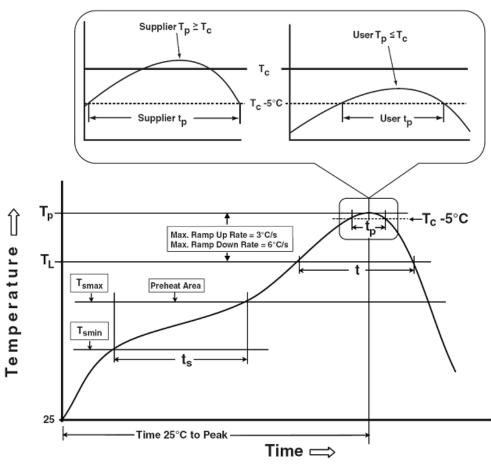
#### PPAK5x6-8L







### **Classification Profile**



#### **Classification Reflow Profiles**

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly	
Preheat & Soak	100 °C	150 °C	
Temperature min (T <sub>smin</sub> )	150 °C	200 °C	
Temperature max (T <sub>smax</sub> )	60-120 seconds	60-120 seconds	
Time (Tsmin to Tsmax) (t₅)	00-120 Seconds	00-120 seconds	
Average ramp-up rate	2 %0/22224 ***	200/20074	
(T <sub>smax</sub> to T <sub>P</sub> )	3 °C/second max.	3°C/second max.	
Liquidous temperature (T <sub>L</sub> )	183 °C	217 °C	
Time at liquidous (t∟)	60-150 seconds	60-150 seconds	
Peak package body Temperature	Soc Classification Town in table 1	SacClassification Tomain table 2	
(T <sub>p</sub> )*	See Classification Temp in table 1	SeeClassification Tempin table 2	
Time (t <sub>P</sub> )** within 5°C of the specified	20**	30** seconds	
classification temperature (T <sub>c</sub> )	20** seconds		
Average ramp-down rate (Tpto Tsmax)	6 °C/second max.	6 °C/second max.	
Time 25°C to peak temperature	6 minutes max.	8 minutes max.	
*Tales on Control of Control of Tales of the Control of			

<sup>\*</sup>Tolerance for peak profile Temperature (Tp) is defined as a supplier minimum and a user maximum.

<sup>\*\*</sup> Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.

## HY1506C2



Table 1.SnPb Eutectic Process – Classification Temperatures (Tc)

Package Thickness	Volume mm³ <350	Volume mm³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

#### Table 2.Pb-free Process - Classification Temperatures (Tc)

Package	Volume mm³	Volume mm³	Volume mm³
Thickness	<350	350-2000	≥2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

### **Reliability Test Program**

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HTRB	JESD-22, A108	168 Hrs/500 Hrs/1000 Hrs, Bias @ 125°C
PCT	JESD-22, A102	96 Hrs, 100%RH, 2atm, 121°C
ТСТ	JESD-22, A104	500 Cycles, -55°C~150°C

#### **Customer Service**

Worldwide Sales and Service: sales@hymexa.com Technical Support:Technology@hymexa.com Xi'an Huayi Microelectronics Co., Ltd.

No.8928, Shangji Road, Economic and Technological Development Zone, Xi'an, China

TEL: (86-029) 86685706 FAX: (86-029) 86685705 E-mail: sales@hymexa.com Web net: www.hymexa.com